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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/523,990	03/13/2000	Mou-Shiung Lin	MEG99-005	6138
28112 SAILE ACKEI	7590 07/27/200 RMANII <i>C</i>	EXAMINER		
28 DAVIS AV	ENUE	WALSH, DANIEL I		
POUGHKEEP	SIE, NY 12603		ART UNIT	PAPER NUMBER
			2887	
			MAIL DATE	DELIVERY MODE
			07/27/2009	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)		
09/523,990	LIN ET AL.		
Examiner	Art Unit		
DANIEL WALSH	2887		

	DANIEL WALSH	2007	
The MAILING DATE of this communication appe	ars on the cover sheet with the	correspondence add	ress
THE REPLY FILED 13 July 2009 FAILS TO PLACE THIS APPL	ICATION IN CONDITION FOR AL	LOWANCE.	
<ol> <li>M The reply was filed after a final rejection, but prior to or on application, applicant must limely file one of the following application in condition for allowance; (2) a Notice of Appendors for Continued Examination (RCE) in compliance with 37 C periods:</li> </ol>	replies: (1) an amendment, affidavi eal (with appeal fee) in compliance	t, or other evidence, w with 37 CFR 41.31; or	hich places the (3) a Request
a) The period for reply expires months from the mailing	date of the final rejection.		
b) The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire la Examiner Note: If box 1 is checked, check either box (a) or (	dvisory Action, or (2) the date set forth ater than SIX MONTHS from the mailing	date of the final rejection	in.
MONTHS OF THE FINAL REJECTION. See MPEP 706 076. Extensions of time may be obtained under 37 CFR 1.136(a). The have been filed is the date for purposes of determining the period of act under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the set for thin (b) above, if checked. Any reply received by the Office later may reduce any evamed patent term adjustment. See 37 CFR 1.704(b).	).  on which the petition under 37 CFR 1.1 ension and the corresponding amount hortened statutory period for reply origi than three months after the mailing dat	36(a) and the appropriate of the fee. The appropriate nally set in the final Office	e extension fee ate extension fee e action; or (2) as
NOTICE OF APPEAL			
<ol> <li>The Notice of Appeal was filed on         filing the Notice of Appeal (37 CFR 41.37(a)), or any exter Notice of Appeal has been filed, any reply must be filed with AMENDMENTS     </li> </ol>	sion thereof (37 CFR 41.37(e)), to	avoid dismissal of the	
The proposed amendment(s) filed after a final rejection, by	out prior to the date of filing a brief	will not be entered be	Callea
(a) ☐ They raise new issues that would require further cor			cause
(b) They raise the issue of new matter (see NOTE below		2 201011/,	
(c) They are not deemed to place the application in bett appeal; and/or		ducing or simplifying th	ne issues for
(d) They present additional claims without canceling a c	corresponding number of finally reje	ected claims.	
NOTE: (See 37 CFR 1.116 and 41.33(a)).			
<ol> <li>The amendments are not in compliance with 37 CFR 1.12</li> </ol>	1. See attached Notice of Non-Co	mpliant Amendment (I	PTOL-324).
<ol><li>Applicant's reply has overcome the following rejection(s):</li></ol>			
<ol> <li>Newly proposed or amended claim(s) would be all non-allowable claim(s).</li> </ol>	owable if submitted in a separate,	imely filed amendmer	nt canceling the
7. For purposes of appeal, the proposed amendment(s): a) [ how the new or amended claims would be rejected is prov The status of the claim(s) is (or will be) as follows: Claim(s) allowed: Claim(s) objected to: Claim(s) rejected: Claim(s) withdrawn from consideration:		l be entered and an ex	xplanation of
AFFIDAVIT OR OTHER EVIDENCE			
The affidavit or other evidence filed after a final action, but because applicant failed to provide a showing of good and was not earlier presented. See 37 CFR 1.116(e).			
<ol> <li>The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to o showing a good and sufficient reasons why it is necessary</li> </ol>	vercome <u>all</u> rejections under appea	al and/or appellant fail:	s to provide a
<ol> <li>The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER</li> </ol>	n of the status of the claims after er	ntry is below or attach	ed.
<ol> <li>The request for reconsideration has been considered but see note below.</li> </ol>	does NOT place the application in	condition for allowan	ce because:
<ol> <li>Note the attached Information Disclosure Statement(s). (</li> <li>Other:</li> </ol>	PTO/SB/08) Paper No(s).		
	/DANIEL WALSH/ Primary Examiner, Art U	nit 2887	

NOTE: The Applicants arguments have been considered, but do not place the application in better condition for allowance. Re the Applicants argument that the claims are patentably distinguished over Hilkia et al. Himmasa/Flip Chip (of record), the Examiner respectfully disagrees. Hikita et al. teaches that the information is on the back face of the semiconductor chip, but is slient to a transparent coating for covering it (as discussed in the action). Himmasa is relied upon for teaching a transparent coating over upof information for protection/security. Regardless of the mention of a mold in Hikita et al., the Examiner notes that covering identification as taught by Hikita et al., with an information covering material such as Himmasa, is still believed to be obvious in order to have protection/security. The Examiner reiterates that the protecting coating of Himmasa (4) is being relied upon for covering identification information, and therefore covering the information of Hikita et al. with such a coating, would therefore provide the expected results of protection/security.

Re the Applicants argument the package material 2 is not transparent, the Examiner notes that material 4, which covers the information, is being relied upon for a transparent coating for information, and not that package 2 is a transparent coating, where package 2 is capable of being interpreted as a semiconductor chip.

Re Applicants arguments regarding the rejection in view of Hyozo et al./Hiromasa/Flip Chip, similar reasoning applies. Hyozo et al. teaches information on a chip. Hiromasa is relied upon for teaching a protective coating over the information, the coating being transparent, as discussed above, for security. Having a laminate layer does not preclude the use of a protective layer, such as that taught by Hiromasa.

Generally, the Examiner notes that Hiromasa is relied upon for teaching a transparent coating to protect/provide security to information. Such a coating is believed to be obvious to one of ordinary skill in the art, to apply over information, for such predicted results. The Examienr does not believe that the entire structure of Hiromasa need be used when combined with other references, as it is primarily used for its teachings of a transparent coating over information, that is deemed applicable to other substrates that ever information on them, in order to protect/secure the firnoamtion therewithin, without requiring the complete structure of Hiromasa to be included. ADditionally, the Examiner does not believe the teaching of a laminate precludes the use of the Hiromasa coating.

The Examiner notes that it appears that the Applicant is arguing that the combination of references would require combinations of all of the elements of each reference, when the Examiner notes that he is not necessarily relying on all elements of a specific teaching. For example, the Examiner notes that it would be within the ordinary skill in the art to use the transparent information coating of Hiromasa in other applications/structures, and does not require the specific structure as taught by Hiromasa to yield expected results of security/protection.